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19270 U.S. PTO  
 10/800959  
 031504

22764 U.S. PTO  
 031504

Mail Stop Patent Applications  
 Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, Virginia 22313-1450

Enclosed for filing are the following patent application papers:

Docket No.: DP-311030

Inventors : HUGH R. HUNKELER

Title : METHOD OF MANUFACTURING A SEALED ELECTRONIC  
 MODULE

Filing Fee Formula

Basic Fee .....	\$	770.00
Additional Fees:		
Number of independent claims in excess of 3, times \$86.00 .....	\$	0.00
Number of claims in excess of 20, times \$18.00 .....	\$	0.00
Multiple dependent claim, add \$290.00 .....	\$	0.00
Total Filing Fee .....	\$	770.00

The patent specification DP-311030 entitled METHOD OF MANUFACTURING A SEALED ELECTRONIC MODULE and filed in the Patent and Trademark Office herewith is the patent specification for which the inventor(s) executed the Declaration enclosed herewith.

Please charge the \$ 770.00 filing fee to DELPHI TECHNOLOGIES INC. Deposit Account No. 50-0831.

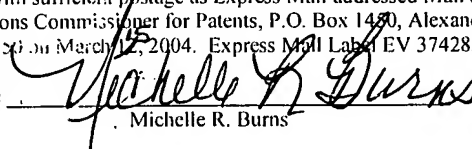


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Enclosures

I hereby certify that this document is being deposited with the United States Postal Service with sufficient postage as Express Mail addressed Mail Stop Patent Applications Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450 on March 12, 2004. Express Mail Label EV 374283069 US

Signature



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